

December 2024

REACH Statement

The Regulation (EC) No 1907/2006 on Registration, Evaluation, Authorization and Restriction of Chemicals, also known as REACH, shall primarily ensure protection of human health and the environment. Therefore it stipulates various obligations for different types of economic operators.

The current list of SVHCs ("Candidate List") is published by the European Chemicals Agency ("ECHA") and may be accessed at <https://echa.europa.eu/en/candidate-list-table>.

We hereby confirm that the selected components, according to the supplier's declaration, if they are declared, meets all requirements of the applicable EU Regulation 1907/2006/EU (REACH).

Some products may assembled with components that uses Lead (CAS 7439-92-1) inside the component as high temperature melting point. Some products may assembled with displays that uses Boric acid (CAS 10043-35-3 or CAS 11113-50-1) for the polarizer of displays.

As far as SVHC over 0.1 percent by weight were reported by our suppliers, these are communicated to our customers.

RoHS Statement

The Directive 2011/65/EU on the Restriction of the use of certain Hazardous Substances (RoHS II), replacing Directive 2002/95/EC (RoHS I), targets Electrical and Electronic Equipment (EEE) in order to avoid adverse impacts on human health and the environment. RoHS Directive 2011/65/EU was amended by the Directive (EU) 2015/863, which was published in June 2015. Four additional substances (phthalates) were added to Annex II of the original RoHS Directive. The provisions regarding the restriction of the newly added substances in 'Electrical and Electronic Equipment' apply from 22.07.2019. For medical devices and for monitoring and control instruments there is an additional two-year grace period.

We hereby confirm that the selected components, according to the supplier's declaration, if they are declared, meets all requirements of the applicable EU Regulations 2011/65/EU and 2015/863/EU.

Some products may assembled with components that relate to the RoHS exemption 6(c) "Copper alloy containing up to 4 % lead by weight", 7(a) "Lead in high melting temperature type solders (i.e. lead- based alloys containing 85 % by weight or more lead)" or 7(c)-I "Electrical and electronic components containing lead in a glass or ceramic. other than dielectric ceramic in capacitors, e.g., piezo electronic devices, or in a glass or ceramic matrix compound"